General Description

The MAX3186 is a complete DCE RS-232 serial port designed to meet the stringent ESD requirements of the European community. All transmitter outputs and receiver inputs are protected to ±15kV using IEC 1000-4-2 Air-Gap Discharge, ±8kV using IEC 1000-4-2 Contact Discharge, and ±15kV using the Human Body Model.

The MAX3186 has five RS-232 transmitters, three RS-232 receivers, and no charge pump, optimizing it for operation in modern applications. It is guaranteed to run at data rates up to 230kbps, providing compatibility with popular software for communicating with personal computers. Power-supply current is less than 300µA for Inp and iss, and less than 1mA for Icc.

The MAX3186 is available in an SO package and in the tiny SSOP that further reduces board space.

Applications

Modems

ISDN Modems

Instruments

Equipment Meeting IEC1000-4-2

Features

- Enhanced ESD Protection: ±15kV--Human Body Model
 - ±8kV--iEC1000-4-2, Contact Discharge ±15kV--IEC1000-4-2, Air-Gap Discharge
- ◆ Latchup Free During an ESD Event
- ♦ 20-Pin SSOP or SO Packages
- ♦ Guaranteed 230kbps Data Rate
- **♦ Flow-Through Pinout**
- ♦ Complete DCE Serial Port

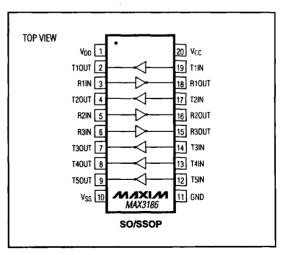
Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE
MAX3186CWP	0°C to +70°C	20 SO
MAX3186CAP	0°C to +70°C	20 SSOP
MAX3186EWP	-40°C to +85°C	20 SO
MAX3186EAP	-40°C to +85°C	20 SSOP

Typical Operating Circuit

MIXIM MAXIM T2 RS-232 TTL/CMOS TTL/CMOS LOGIC LOGIC INTERCONNECTING 1/0 CABLE T21

Pin Configuration



MIXIM

Maxim Integrated Products 2-115

ABSOLUTE MAXIMUM RATINGS

V _{CC}	0.3V to +7V
V _{DD}	
Vss	+0.3V to -14V
Input Voltages	
T _{IN}	0.3V to +6V
RIN	±30V
Output Voltages	
TOUT	±15V
Rout	0.3V to (Vcc + 0.3V)
Short-Circuit Duration	
Tour (one at a time)	Continuous
Bour (one at a time)	Continuous

Continuous Power Dissipation (T _A = +70°C) Wide SO (derate 10.00mW/°C above +70°C)	C)800mW
SSOP (derate 8.00mW/°C above +70°C)	640mW
Operating Temperature Ranges	
MAX3186C_P	0°C to +70°C
MAX3186E_P	40°C to +85°C
Storage Temperature Range	65°C to +160°C
Lead Temperature (soldering, 10sec)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +4.5V \text{ to } +5.5V, V_{DD} = +10.8V \text{ to } +13.2V, V_{SS} = -10.8V \text{ to } -13.2V, T_A = T_{MIN} \text{ to } T_{MAX}$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DC CHARACTERISTICS	•	<u> </u>				
Operating Voltage Range	Vcc		4.5	_	5.5	٧
	VDD		10.8		13.2	
	VSS		-13.2		-10.8	
	Icc	No load		230	1000	
Supply Current	loo	No load		280	750	μΑ
	Iss	No load		280	750	
LOGIC						
Input Logic Threshold Low	VILT	Tin			0.8	V
Input Logic Threshold High	VIHT	TIN	2.0			٧
Input Leakage Current	I			0.01	1	μA
Output Voltage Low	Volr	Rout; Isink = 3.2mA			0.4	V
Output Voltage High	Vohr	ROUT: ISOURCE = 1mA	V _{CC} - 0.6			٧
TRANSMITTER OUTPUTS						
Output Voltage Swing	$V_{DD} = 7.0V$, $V_{SS} = -7.0V$, $R_L = 3k\Omega$	±5.0			V	
Output Voltage Swing		$V_{DD} = 12V$, $V_{SS} = -12V$, $R_L = 3k\Omega$	±9.5			٧
Transmitter Output Resistance		VCC = VDD = VSS = 0V, VT_OUT = ±2V	300			Ω
RS-232 Output Short-Circuit Current				±35	±60	mA
RECEIVER INPUTS			•			
Receiver Input Voltage Operating Range		,	-25		25	٧
RS-232 Input Threshold Low			0.75			V
RS-232 Input Threshold High					2.4	٧
RS-232 Input Hysteresis				0.65		V
RS-232 Input Resistance			3	5	7	kΩ
Receiver Output Short-Circuit Current				±10		mA

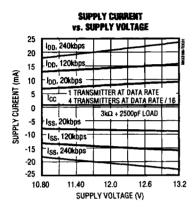
ELECTRICAL CHARACTERISTICS (continued)

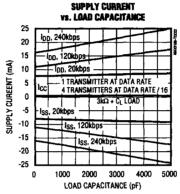
 $(V_{CC} = +4.5V \text{ to } +5.5V, V_{DD} = +10.8V \text{ to } +13.2V, V_{SS} = -10.8V \text{ to } -13.2V, T_A = T_{MIN} \text{ to } T_{MAX}$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.)

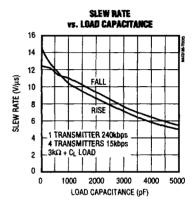
PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
ESD CHARACTERISTICS	•	·			-			
		Human Body Model			±15			
ESD Protection		IEC1000-4-2 (Contact Discharge) IEC1000-4-2 (Air-Gap Discharge)			±8		kV	
				±15				
TIMING CHARACTERISTICS								
Transmitter Output Propagation Delay, Low to High	tPLHT	$V_{DD} = 12V$, $V_{SS} = -12V$, $R_L = 3k\Omega$, $C_L = 1000pF$, $T_A = +25^{\circ}C$				4	μs	
Transmitter Output Propagation Delay, High to Low	tphlt	$V_{DD} = 12V$, $V_{SS} = -12V$, $R_L = 3k\Omega$, $C_L = 1000pF$, $T_A = +25^{\circ}C$		-		4	μs	
Transmitter Propagation Delay Skew, tplht - tphlt	tskt	V _{DD} = 12V, V _{SS} = -12V, R _L = C _L = 1000pF, T _A = +25°C	: 3kΩ,			0.4	μs	
Transition Output Slew Rate	$R_L = 3k\Omega$ to $7k\Omega$ SR measured from	$V_{DD} = 12V$, $V_{SS} = -12V$, $R_L = 3k\Omega$ to $7k\Omega$,	C _L = 150pF to 2500pF	4		30	V/µs	
		or -3V to +3V, Figure 3,	C _L = 50pF to 1000pF	8		30		
Receiver Output Propagation Delay, Low to High	tpLHR	V _{CC} = 5V, C _L = 50pF, T _A = +25°C				4.0	μs	
Receiver Output Propagation Delay, High to Low	t _{PHLR}	V _{CC} = 5V, C _L = 50pF, T _A = +25°C				4.0	μs	
Receiver Propagation Delay Skew, tpLHR - tpHLR	tskr	V _{CC} = 5V, C _L = 50pF, T _A = +25°C				0.4	рѕ	
Guaranteed Data Rate	DB	$V_{SS} = -12V,$ $V_{SS} = -12V,$ $R_{L} = 3k\Omega \text{ to } 7k\Omega,$	C _L = 50pF to 2500pF	120			kbps	
			C _L = 50pF to 1000pF	230			Koha	

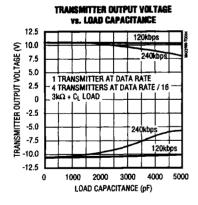
Typical Operating Characteristics

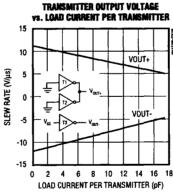
 $(V_{CC} = +5.0V, V_{DD} = +12.0V, V_{SS} = -12.0V, T_A = +25^{\circ}C$, unless otherwise noted.)

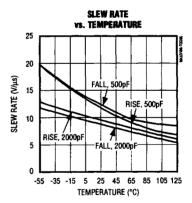












Pin Description

PIN	NAME	FUNCTION
1	Voo	Supply-Voltage Input, +10.8V to +13.2V
2, 4, 7, 8, 9	T10UT-T50UT	Transmitter Outputs, swing between V _{DD} and V _{SS}
3, 5, 6	R1IN, R2IN, R3IN	Receiver Inputs
10	Vss	Supply-Voltage Input, -10.8V to -13.2V
11.	GND	Ground. Connect to system ground.
12, 13, 14, 17, 19	T5IN-T1IN	Transmitter Inputs
15, 16, 18	R3OUT, R2OUT, R1OUT	Receiver Outputs, swing between GND and VCC
20	Vcc	Supply-Voltage Input, +4.5V to +5.5V

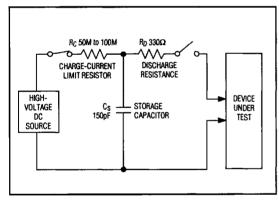


Figure 1a. IEC1000-4-2 ESD Test Model

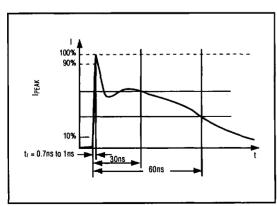


Figure 1b. IEC1000-4-2 ESD Generator Current Waveform

Detailed Description

±15kV ESD Protection

As with all Maxim devices, ESD-protection structures are incorporated on all pins to protect against electrostatic discharges encountered during handling and assembly. The MAX3186 driver outputs and receiver inputs have extra protection against static electricity found in normal operation. Maxim's engineers developed state-of-the-art structures to protect these pins against ESD of ±15kV, without damage. After an ESD event, the MAX3186 continues working without latchup.

ESD protection can be tested in several ways. The transmitter outputs and the receiver inputs are characterized for protection to the following:

- 1) ±15kV using the Human Body Model
- ±8kV using the Contact-Discharge Method specified in IEC1000-4-2 (formerly IEC801-2)
- 3) ±15kV using the Air-Gap Method specified in IEC1000-4-2 (formerly IEC801-2)

ESD Test Conditions

ESD performance depends on a number of conditions. Contact Maxim for a reliability report that documents test setup, methodology, and results.

Human Body Model

Figure 2a shows the Human Body Model, and Figure 2b shows the current waveform it generates when discharged into a low impedance. This model consists of a 100pF capacitor charged to the ESD voltage of interest, which is then discharged into the device through a $1.5k\Omega$ resistor.

IEC1000-4-2

The IEC1000-4-2 standard covers ESD testing and performance of finished equipment; it does not specifically refer to integrated circuits. The MAX3186 helps you design equipment that meets Level 4 (the highest level) of IEC1000-4-2, without additional ESD-protection components.

The main difference between tests done using the Human Body Model and IEC1000-4-2 is higher peak current in IEC1000-4-2. Because series resistance is lower in the IEC1000-4-2 ESD test model (Figure 1a), the ESD withstand voltage measured to this standard is generally lower than measured using the Human Body Model. Figure 1b shows the current waveform for the ±8kV IEC1000-4-2 Level 4 ESD Contact-Discharge test.

The Air-Gap test involves approaching the device with a charge probe. The Contact-Discharge method connects the probe to the device before the probe is energized.

Machine Model

The Machine Model for ESD testing uses a 200pF storage capacitor and zero-discharge resistance. It mimics the stress caused by handling during manufacturing and assembly. Of course, all pins (not just RS-232 inputs and outputs) require this protection during manufacturing. Therefore, the Machine Model is less relevant to the I/O ports than are the Human Body Model and IEC1000-4-2.

_Applications Information

Use proper layout to ensure other devices on your board are not damaged in an ESD strike. Currents as high as 60A can instantaneously pass into the ground, so be sure to minimize the ground-lead return path to the power supply. A separate return path to the power supply is recommend. Trace widths should be greater than 40 mils. Bypass Vcc, VDD, and Vss with 0.1µF capacitors as close to the part as possible to ensure maximum ESD protection.

Tie any transmitter inputs to GND or VCC. No external protection diodes are needed because the MAX3186 is not sensitive to power-supply sequencing.

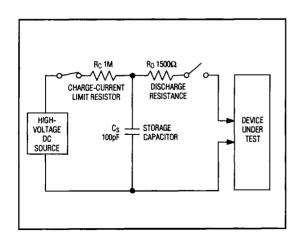


Figure 2a. Human Body ESD Test Model

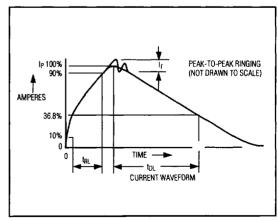


Figure 2b. Human Body Model Current Waveform

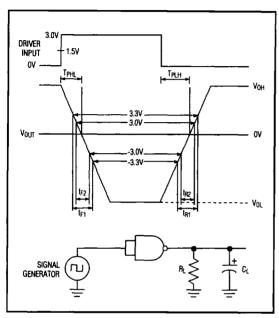
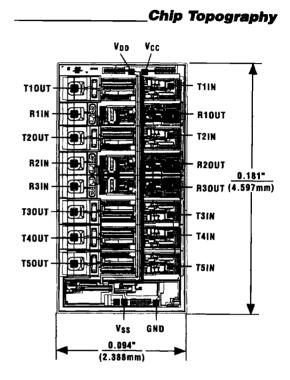


Figure 3. Slew-Rate Test Circuit and Timing Diagram



TRANSISTOR COUNT: 195 SUBSTRATE CONNECTED TO GND